

Form PTO-1595 (Rev. 12-08)
OMB No. 0651-0027 (exp. 01/31/2009)

U.S. DEPARTMENT OF COMMERCE
United States Patent and Trademark Office

RECORDATION FORM COVER SHEET PATENTS ONLY

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies)

Michael Todd Wyant
Patricia Sabran Conde
Vikas Gupta
Rajiv Dunne
Emerson Mamarin Enipin

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: Texas Instruments Incorporated

Internal Address: MS 3999

Street Address: 12500 TI Boulevard

City: Dallas

State: Texas

Country: us Zip: 75243

Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s) 3/12/12; 3/28/12; 3/12/12; 2/24/12; 3/25/12

☒ Assignment

☐ Merger

☐ Security Agreement

☐ Change of Name

☐ Joint Research Agreement

☐ Government Interest Assignment

☐ Executive Order 9424, Confirmatory License

☐ Other _____

4. Application or patent number(s):

☐ This document is being filed together with a new application.

A. Patent Application No.(s)

13/431,758

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Texas Instruments Incorporated

Internal Address: MS 3999

Street Address: P.O. Box 655474

City: Dallas

State: Texas Zip: 75265

Phone Number: (214) 479-1247

Fax Number: (214) 479-1280

Email Address: _____

6. Total number of applications and patents involved: 1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00

☒ Authorized to be charged to deposit account

☐ Enclosed

☐ None required (government interest not affecting title)

8. Payment Information

Deposit Account Number 200668

Authorized User Name Wade J. Brady

9. Signature:

/William P. O'Meara/

Signature

April 16, 2012

Date

William P. O'Meara, Esq.

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

16

Documents to be recorded (including cover sheet) should be faxed to (571) 273-0140, or mailed to:
Mail Stop Assignment Recordation Services, Director of the USPTO, P.O. Box 1450, Alexandria, V.A. 22313-1450

PATENT

700484195

REEL: 028071 FRAME: 0949

CH \$40.00 200668 13431758

Application No. 13/431,758

Attorney Docket No. TI-71076

ASSIGNMENT

WHEREAS, I, the undersigned inventor (or one of the undersigned joint inventors), of residence as listed, having invented certain new and useful improvements as below entitled, for which application for United States Letters Patent is made.

WHEREAS, TEXAS INSTRUMENTS INCORPORATED, a corporation organized and existing under the laws of the State of Delaware, with a place of business at 12500 TI Boulevard, MS 3999, Dallas, Texas 75243, is desirous of acquiring my entire right, title and interest in and to the said invention, and to the said application and any Letters Patent that may issue thereon.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, I hereby sell and assign unto the said TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my entire right, title and interest in and to the said invention and in and to the said application(s) and all patents which may be granted therefor, and all divisions, reissues, substitutions, continuations, and extensions thereof; and I hereby authorize and request the Patent and Trademark Office to issue all patents for said invention, or patents resulting therefrom, to the said TEXAS INSTRUMENTS INCORPORATED, as assignee of my entire right, title and interest.

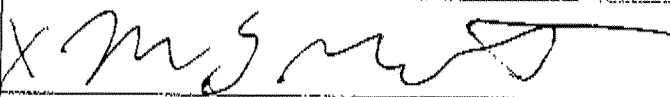
I also hereby sell and assign to TEXAS INSTRUMENTS INCORPORATED, its successors and assigns, my corresponding rights to the invention disclosed in said application in all other countries of the world, including the right to claim priority, file applications and obtain patents under the terms of the Paris Convention for the Protection of Industrial Property, and further agree to execute any and all patent applications, assignments, affidavits, and any other papers in connection therewith necessary to perfect such rights.

I hereby further agree that I will communicate to said TEXAS INSTRUMENTS INCORPORATED, or to its successors, assigns, and legal representatives, any facts known to me respecting said invention, and at the expense of said assignee company, testify in any legal proceedings, sign all lawful papers, execute all divisional, continuation, reissue and substitute applications, make all lawful oaths, and generally do everything possible to aid said TEXAS INSTRUMENTS INCORPORATED, its successors, assigns and nominees to obtain and enforce proper patent protection for said invention in all countries.

I authorize the later insertion of the nonprovisional application number and filing date hereinbelow.

IN WITNESS WHEREOF, I hereunto set hand and seal this day and year;

TITLE	STACKED SEMICONDUCTOR PACKAGE		
NONPROVISIONAL APPLICATION NO.	13/431,758	FILING DATE	March 27, 2012

SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	Michael Todd Wyant
DATE	X 3/12/12
RESIDENCE (CITY AND STATE)	Dallas, Texas

Application No. 13/431,758

Attorney Docket No. TI-71076

SIGNATURE OF INVENTOR	X
PRINTED NAME OF INVENTOR	Patricia Sabran Conde
DATE	X
RESIDENCE (CITY AND STATE)	Pasig City, Philippines

SIGNATURE OF INVENTOR	X
PRINTED NAME OF INVENTOR	Vikas Gupta
DATE	X
RESIDENCE (CITY AND STATE)	Dallas, Texas

SIGNATURE OF INVENTOR	X
PRINTED NAME OF INVENTOR	Rajiv Dunne
DATE	X
RESIDENCE (CITY AND STATE)	Murphy, Texas

Page 3

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Attorney Docket No. TI-71076

SIGNATURE OF INVENTOR	X
PRINTED NAME OF INVENTOR	Emerson Mamarin Enipin
DATE	X
RESIDENCE (CITY AND STATE)	Angeles City, Philippines

SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	
DATE	
RESIDENCE (CITY AND STATE)	

SIGNATURE OF INVENTOR	
PRINTED NAME OF INVENTOR	
DATE	
RESIDENCE (CITY AND STATE)	

After recording, return Assignment to:

Jonathon Scott
Texas Instruments Incorporated
PO Box 655474, M/S 3999
Dallas, TX 75265

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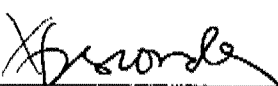
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DATE	X
RESIDENCE (CITY AND STATE)	Dallas, Texas

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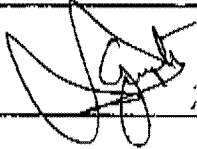
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DATE	X
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SIGNATURE OF INVENTOR	X 
PRINTED NAME OF INVENTOR	Vikas Gupta
DATE	X Mar 12, 2012
RESIDENCE (CITY AND STATE)	Dallas, Texas

SIGNATURE OF INVENTOR	X
PRINTED NAME OF INVENTOR	Rajiv Dunne
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RESIDENCE (CITY AND STATE)	Murphy, Texas

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RESIDENCE (CITY AND STATE)	Dallas, Texas

PATENT

RECORDED: 04/16/2012

REEL: 028071 FRAME: 0960

TOTAL P.12